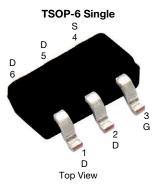
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Vishay Siliconix

# N-Channel 30 V (D-S) MOSFET



Marking code: AY

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	30				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.040				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.050				
Q <sub>g</sub> typ. (nC)	2.8				
I <sub>D</sub> (A) <sup>d</sup>	6.3				
Configuration	Single				

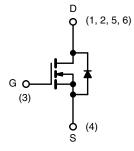
#### **FEATURES**

- TrenchFET® power MOSFET
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



#### **APPLICATIONS**

- · Load switch
- HDD
- DC/DC converter



N-Channel MOSFET

ORDERING INFORMATION	
Package	TSOP-6
Lead (Pb)-free	Si3456DDV-T1-E3
Lead (Pb)-free and halogen-free	Si3456DDV-T1-GE3

ABSOLUTE MAXIMUM RATING	(IA - 20 O, C			<u> </u>	
PARAMETER Drain-source voltage		SYMBOL	LIMIT	UNIT	
		$V_{DS}$	30	V	
Gate-source voltage		V <sub>GS</sub>	± 20		
	T <sub>C</sub> = 25 °C		6.3		
Oti	T <sub>C</sub> = 70 °C	1 , $\square$	5.1		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	l <sub>D</sub>	5 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C	1	4 a, b	А	
Pulsed drain current		I <sub>DM</sub>	20		
	T <sub>C</sub> = 25 °C		2.2		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	1.4 <sup>a, b</sup>		
	T <sub>C</sub> = 25 °C		2.7	w	
Maximum power dissipation	T <sub>C</sub> = 70 °C	1 , —	1.7		
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.7 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C	†	1.1 <sup>a, b</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150		
Soldering recommendations (peak temperature)			260	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient a, c	t ≤ 5 s	R <sub>thJA</sub>	61	74	°C/W	
Maximum junction-to-foot (drain)	Steady state	R <sub>thJF</sub>	38	46	] 0/00	

#### **Notes**

- a. Surface mounted on 1" x 1" FR4 board
- b. t = 5 s
- c. Maximum under steady state conditions is 120 °C/W
- d. Based on T<sub>C</sub> = 25 °C



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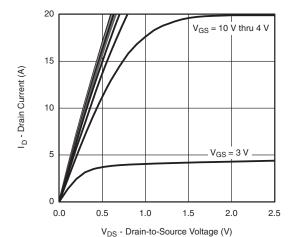
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS			MAX.	UNIT	
Static							
Drain-source breakdown voltage	$V_{DS}$	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	30	_	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	32	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-5	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.2	-	3	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zoro gata voltaga drain augrant	1	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V	-	-	1	μΑ	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	10		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	15	_	-	Α	
Drain course on state registance 3	В	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5 A	-	0.033	0.040	0	
Drain-source on-state resistance a	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 4.5 A	-	0.041	0.050	Ω	
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 5 A	-	15	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	325	-		
Output capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	60	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>		-	30	-		
Talal and a decree	Q <sub>g</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5 A	-	6	9		
Total gate charge			-	2.8	4.2	0	
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$	-	1.1	-	nC	
Gate-drain charge	Q <sub>gd</sub>		-	0.8	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz	0.6	2.8	5.6	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	12	18		
Rise time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_L = 3.8 \Omega$	-	13	20		
Turn-off delay time	t <sub>d(off)</sub>	$I_D\cong 4$ A, $V_{GEN}=4.5$ V, $R_g=1~\Omega$	-	16	25	-	
Fall time	t <sub>f</sub>		-	11	17		
Turn-on delay time	t <sub>d(on)</sub>		-	4	8	ns -	
Rise time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_L = 3.8 \Omega$	-	9	18		
Turn-off delay time	t <sub>d(off)</sub>	$I_D\cong 4$ A, $V_{GEN}=10$ V, $R_g=1$ $\Omega$	-	11	20		
Fall time	t <sub>f</sub>		-	8	15		
<b>Drain-Source Body Diode Characteristi</b>	cs						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	1.2	^	
Pulse diode forward current	I <sub>SM</sub>		-	-	20	Α	
Body diode voltage	$V_{SD}$	I <sub>S</sub> = 4 A, V <sub>GS</sub> = 0 V	-	0.8	1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	11	20	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 4 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	4	8	nC	
Reverse recovery fall time	ta	T <sub>J</sub> = 25 °C	-	6	-		
Reverse recovery rise time	t <sub>b</sub>		_	5	_	ns	

#### Notes

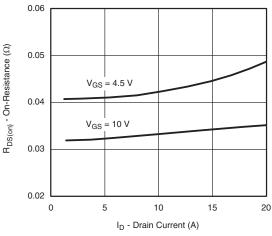
- a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

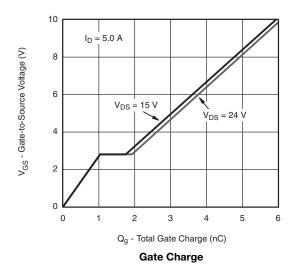


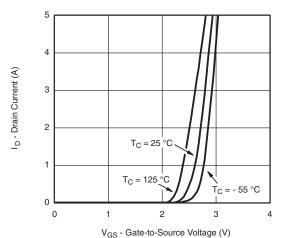


#### **Output Characteristics**

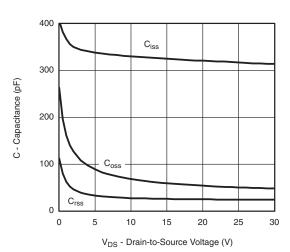


On-Resistance vs. Drain Current

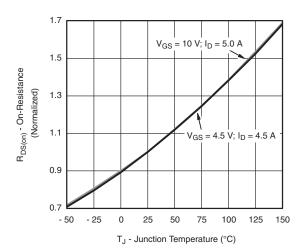




**Transfer Characteristics** 

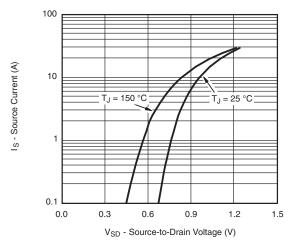


Capacitance

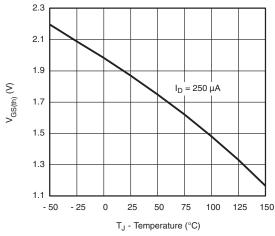


On-Resistance vs. Junction Temperature

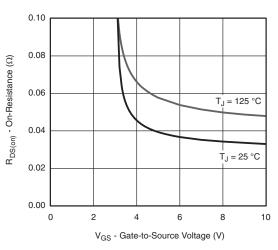




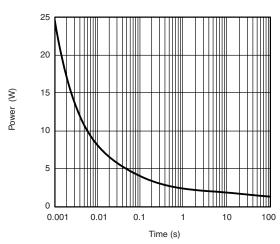
#### Source-Drain Diode Forward Voltage



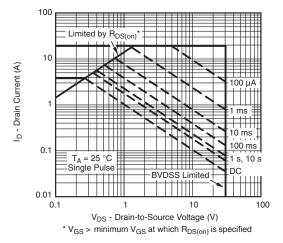
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage

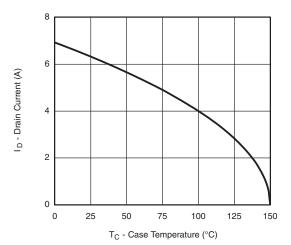


Single Pulse Power

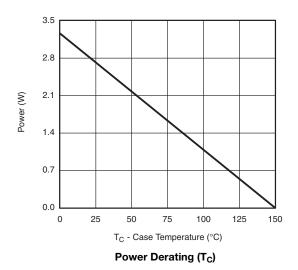


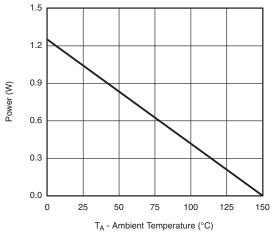
Safe Operating Area, Junction-to-Ambient





#### Current Derating a



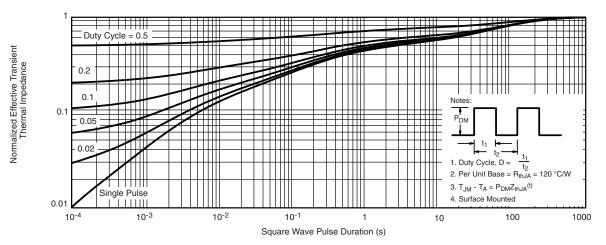


Power Derating (T<sub>A</sub>)

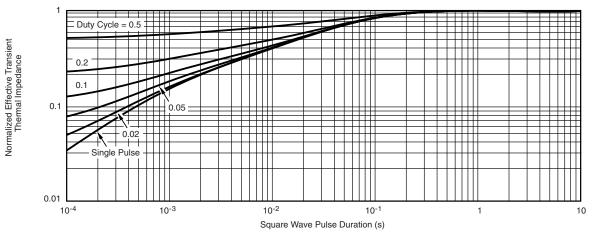
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

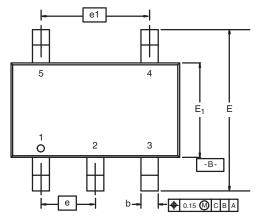
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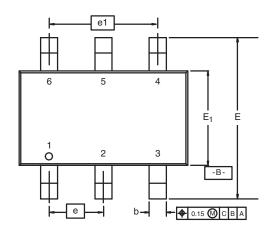




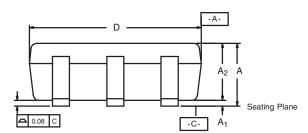
TSOP: 5/6-LEAD

**JEDEC Part Number: MO-193C** 

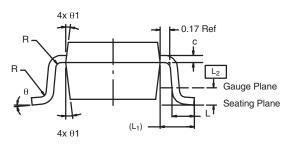




**5-LEAD TSOP** 





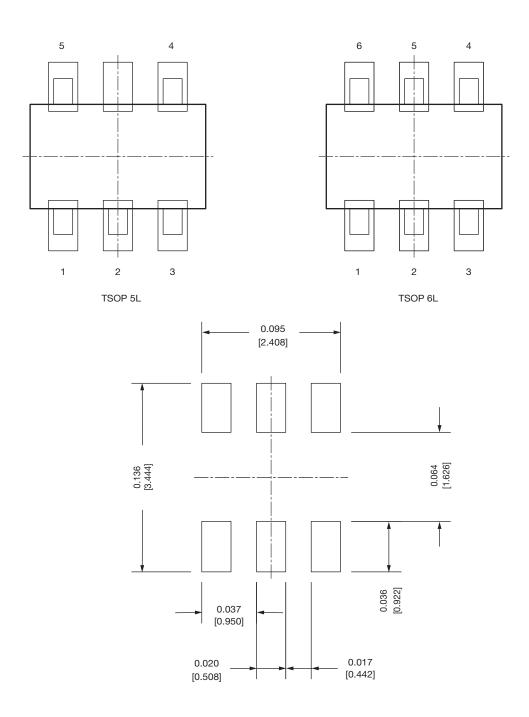


	MIL	LIMETER	RS	INCHES			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.91	-	1.10	0.036	-	0.043	
A <sub>1</sub>	0.01	-	0.10	0.0004	-	0.004	
A <sub>2</sub>	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
E	2.70	2.85	2.98	0.106	0.112	0.117	
E <sub>1</sub>	1.55	1.65	1.70	0.061	0.065	0.067	
е		0.95 BSC			0.0374 BSC		
e <sub>1</sub>	1.80	1.90	2.00	0.071	0.075	0.079	
L	0.32	-	0.50	0.012	-	0.020	
L <sub>1</sub>		0.60 Ref			0.024 Ref		
L <sub>2</sub>	0.25 BSC			0.010 BSC			
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
θ1	7° Nom			7° Nom			
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540							

Document Number: 71200 18-Dec-06



## Recommended Land Pattern For TSOP-5L / TSOP-6L



### Note

• All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022 DWG: 3010



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